

## EAST Search History

| Ref # | Hits    | Search Query  | DBs  | Default Operator | Plurals | Time Stamp          |
|-------|---------|---|--|------------------|---------|---------------------|
| L1    | 12      | JP-2001102758-\$\$.did. jp-09136943-\$.did. jp-2003020327-\$.did. jp-2004149577-\$.did. jp-2003128877-\$.did. jp-11269355-\$.did. | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2009/01/04<br>11:37 |
| L2    | 1182792 | silica (silicon adj2 (oxide dioxide)) "sio2" "sio.sub.2"  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2009/01/04<br>12:15 |
| L3    | 719270  | epox\$6 diepox\$6 triepox\$6 polyepox\$6 glycidyl\$ diglycidyl\$ triglycidyl\$ tetraglycidyl\$ polyglycidyl\$                     | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2009/01/04<br>12:15 |
| L4    | 20378   | (L2 silicate) with (lamellar planar plane flake)  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2009/01/04<br>12:15 |
| L5    | 30      | motobe-h\$.in. motobe-h\$-\$.in.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2009/01/04<br>12:15 |
| L6    | 613     | hibino-a\$.in. hibino-a\$-\$.in.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2009/01/04<br>12:15 |
| L7    | 54635   | ito-k\$.in. ito-k\$-\$.in.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2009/01/04<br>12:15 |
| L8    | 9       | L5 and L6 and L7  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2009/01/04<br>12:15 |
| L9    | 914596  | matsushita.as.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR               | ON      | 2009/01/04<br>12:15 |

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| L10 | 21     | (L5 L6 L7 L8 L9) and L3 and L4   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/04<br>12:15 |
| L11 | 711991 | (surface adj2 area) "ssa" "s.s.a."   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/04<br>12:16 |
| L12 | 930289 | (particle particulate grain) near5<br>(size diameter micron<br>micrometer nanometer)   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/04<br>12:16 |
| L13 | 41     | (novolak novolac novolak<br>novolac) and L4 and L11 and<br>L12 and ((wiring circuit) adj2<br>board)  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/04<br>12:16 |
| L14 | 7      | (L5 L6 L7 L8 L9) and L3 and<br>L4 and 111 and 112  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/04<br>12:16 |
| L15 | 41     | I3 and (novolak novolac<br>novolak novolac) and L4 and<br>L11 and L12 and ((wiring<br>circuit) adj2 board)   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/04<br>12:19 |
| L16 | 41     | I3 and (novolak novolac<br>novolak novolac) and L4 and<br>L11 and L12 and (((wiring<br>circuit) adj2 board) "pwb"<br>"pcb" "p.w.b." "p.c.b.")  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/04<br>12:19 |
| L18 | 14677  | (428/297.4.ccls. 428/413.ccls.<br>428/414.ccls. 428/415.ccls.<br>428/416.ccls. 428/417.ccls.<br>428/418.ccls. 428/901.ccls.<br>156/325.ccls. 156/326.ccls.<br>156/327.ccls. 156/330.ccls.<br>523/440.ccls. 523/443.ccls.<br>523/466.ccls.) | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/04<br>12:24 |
| L21 | 165    | 118 and I3 and I4  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/04<br>12:25 |
| L22 | 17     | 118 and I3 and I4 and 111 and<br>112   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2009/01/04<br>12:25 |

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| L23 | 2       | I3 clm. and (novolak novolac novolak novolac) clm. and L4 and L11 and L12 and (((wiring circuit) adj2 board) "pwb" "pcb" "p.w.b." "p.c.b." )                   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2009/01/04<br>12:27 |
| S25 | 496814  | silicone polysiloxane<br>polyorganosiloxane<br>polydiorganosiloxane<br>organopolysiloxane<br>organosiloxane<br>diorganopolysiloxane siloxane<br>organosilicone | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2007/02/14<br>09:00 |
| S26 | 317795  | curative hardener (cross adj2 linker) crosslinker ((curing hardening (cross adj2 linking) crosslinking) adj2 (agent promoter))                                 | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2007/06/28<br>14:33 |
| S27 | 1222941 | amine amino diamine diamino triamine triamino polyamine polyamino  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2007/12/12<br>13:13 |
| S28 | 605176  | epox\$6 diepox\$6 triepox\$6 polycyepox\$6 glycidyl\$ diglycidyl \$ triglycidyl\$ tetraglycidyl\$ polyglycidyl\$   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2007/02/14<br>09:01 |
| S34 | 2       | "20060216495".pn.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2008/06/19<br>12:58 |
| S35 | 1       | 2005-152068.NRAN.  | DERWENT  | OR | OFF | 2008/06/19<br>13:01 |
| S36 | 0       | us20060216495-\$did.   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2008/06/19<br>13:02 |
| S37 | 2       | us-20060216495-\$did.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2008/06/19<br>13:02 |
| S38 | 4       | JP-2001102758-\$did.jp-09136943-\$did.jp-200320327-\$did   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2008/06/19<br>13:06 |
| S39 | 6       | JP-2001102758-\$did.jp-09136943-\$did.jp-200320327-\$did   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2008/06/19<br>13:07 |

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| S40 | 1133142 | silica (silicon adj2 (oxide dioxide)) "sio2" "sio.sub.2"  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:08 |
| S41 | 7070    | S40 with (lamellar planar)  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:08 |
| S42 | 692669  | epox\$6 diepox\$6 triepox\$6<br>polyepox\$6 glycidyl\$ diglycidyl\$<br>\$ triglycidyl\$ tetraglycidyl\$<br>polyglycidyl\$ | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:09 |
| S43 | 48      | S42 and (novolak novolac novalak novalac) and S41   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:09 |
| S44 | 684346  | (surface adj2 area) "ssa" "s.s.a."  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:10 |
| S45 | 897248  | (particle particulate grain) near5<br>(size diameter micron micrometer nanometer)   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:11 |
| S46 | 14      | S43 and S44 and S45   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:11 |
| S47 | 19518   | (S40 silicate) with (lamellar planar plane flake)   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:15 |
| S48 | 185     | S47.ab. and S42.ab.   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:15 |
| S49 | 17      | (novolak novolac novalak novalac) and S48   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:16 |

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| S50 | 112    | (novolak novolac novalak novalac) and S47 and S44 and S45                                   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>JIBM_TDB | OR | ON | 2008/06/19<br>13:19 |
| S51 | 38     | (novolak novolac novalak novalac) and S47 and S44 and S45 and ((wiring circuit) adj2 board) | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>JIBM_TDB | OR | ON | 2008/06/19<br>13:20 |
| S52 | 30     | motobe-h\$.in. motobe-h\$-\$.in.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>JIBM_TDB | OR | ON | 2008/06/19<br>13:31 |
| S53 | 598    | hibino-a\$.in. hibino-a\$-\$.in.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>JIBM_TDB | OR | ON | 2008/06/19<br>13:31 |
| S54 | 53474  | ito-k\$.in. ito-k\$-\$.in.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>JIBM_TDB | OR | ON | 2008/06/19<br>13:32 |
| S55 | 9      | S52 and S53 and S54   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>JIBM_TDB | OR | ON | 2008/06/19<br>13:32 |
| S56 | 897711 | matsushita.as.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>JIBM_TDB | OR | ON | 2008/06/19<br>13:33 |
| S57 | 21     | (S52 S53 S54 S55 S56) and S42 and S47   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>JIBM_TDB | OR | ON | 2008/06/19<br>13:34 |
| S58 | 38     | (novolak novolac novalak novalac) and S47 and S44 and S45 and ((wiring circuit) adj2 board) | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>JIBM_TDB | OR | ON | 2008/06/19<br>13:39 |
| S59 | 372    | (interplanar near3 spacing).clm.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>JIBM_TDB | OR | ON | 2008/06/19<br>13:46 |

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| S60 | 34    | S59 and S42  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:47 |
| S61 | 109   | michigan.as. and lamellar  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:48 |
| S62 | 26    | pinnavaia.in. and S42  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:49 |
| S63 | 12    | pinnavaia.in. and S42 and S40  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:50 |
| S64 | 13    | pinnavaia.in. and S42 and S47  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:51 |
| S65 | 0     | S64 and ((wiring circuit) adj2 board)                                  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:54 |
| S66 | 0     | S64 and prepreg  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:55 |
| S67 | 14458 | (S40 silicate) near3 (lamellar planar plane flake layered exfoliat\$4) | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:56 |
| S68 | 2846  | S67 and S42  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:56 |
| S69 | 224   | S68 and ((wiring circuit) adj2 board)                                  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:56 |

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| S70 | 7206   | (S40) near3 (lamellar planar plane flake layered exfoliat\$4)  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:56 |
| S71 | 140    | S69 and S70  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>13:57 |
| S72 | 2      | "20060216495".pn.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:01 |
| S73 | 28     | (novolak novolac novalak novalac) and S71  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:12 |
| S74 | 27     | (cresole resolole cresol resol) and S71  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:12 |
| S75 | 357156 | curative hardener (cross adj2 linker) crosslinker ((curing hardening (cross adj2 linking) crosslinking) adj2 (agent promoter)) | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:13 |
| S76 | 20     | ((phenol phenolic) with S75) and S71   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:13 |
| S77 | 48     | S69 and S70 and (impregnat\$4 prepreg)   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:14 |
| S78 | 13     | S70.ab. and S44.ab. and S45.ab.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:17 |
| S79 | 27004  | (S40) near3 (lamellar planar plane flake layered exfoliat\$4 scaly plate)  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:19 |

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| S80 | 27   | S79.ab. and S44.ab. and S45.ab.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:20 |
| S81 | 47   | S79 same S44 same S45  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:21 |
| S82 | 11   | (S79 same S44 same S45) and<br>(electronic ((wiring circuit) adj2<br>board) prepreg impregnat\$) | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:22 |
| S83 | 2915 | S79.ab. S79.ti.  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:31 |
| S84 | 62   | S83 and S44 and S45  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:31 |
| S85 | 12   | S84 and (((wiring circuit) adj2<br>board) prepreg impregnat\$)                                   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:39 |
| S86 | 1879 | (S40) near3 (crushed)  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:55 |
| S87 | 364  | S86 and S44 and S45  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:56 |
| S88 | 119  | S87 and (((wiring circuit) adj2<br>board) prepreg impregnat\$)                                   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:56 |
| S89 | 12   | "155" and (((wiring circuit) adj2<br>board) prepreg impregnat\$) and<br>S42                      | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:56 |



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| S90 | 36  | S87 and (((wiring circuit) adj2 board) prepreg impregnat\$) and S42  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>14:57 |
| S91 | 10  | S87 and (((wiring circuit) adj2 board) prepreg impregnat\$) and S42 and (novolak novolac novalak novalac)  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>15:03 |
| S92 | 10  | S87 and (((wiring circuit) adj2 board) prepreg impregnat\$) and S42 and (novolak novolac novalak novalac) and (accelerator catalyst)                           | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>15:03 |
| S93 | 439 | ((S40) near3 (crushed fused)) same S44 same S45  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>15:14 |
| S94 | 70  | S93 and (((wiring circuit) adj2 board) prepreg impregnat\$) and S42 and (novolak novolac novalak novalac) and (accelerator catalyst)                           | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>15:15 |
| S95 | 47  | S93 and (((wiring circuit) adj2 board) prepreg impregnat\$) and S42 and (novolak novolac novalak novalac) and (accelerator catalyst) and (prepreg impregnat\$) | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>15:16 |
| S96 | 4   | S93 and (prepreg impregnat\$). ab. and S42.ab.   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>15:18 |
| S97 | 52  | S93 and ((prepreg impregnat\$) same S42)   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>15:19 |
| S98 | 585 | ((S40) near3 (crushed fused)) and ((prepreg impregnat\$) same S42)   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>15:20 |
| S99 | 205 | ((S40) near3 (crushed)) same (S44 S45)) and S44 and S45  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON | 2008/06/19<br>15:21 |

|      |      |  |  |    |     |                     |
|------|------|--|--|----|-----|---------------------|
| S100 | 5    | S99 and ((prepreg impregnat\$)<br>same S42)  | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2008/06/19<br>15:22 |
| S101 | 1    | wo-0151562-\$.dtd.   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2008/06/19<br>15:25 |
| S102 | 1    | 2001-611031.NRAN.  | DERWENT  | OR | OFF | 2008/06/19<br>15:25 |
| S103 | 9621 | 428/297.4.ccls. 428/413.ccls.<br>428/414.ccls. 428/415.ccls.<br>428/416.ccls. 428/417.ccls.<br>428/418.ccls. 428/901.ccls. | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2008/06/19<br>15:28 |
| S104 | 5    | S103 and S99   | US-PGPUB;<br>USPAT; USOCR;<br>FPRS; EPO; JPO;<br>DERWENT;<br>IBM_TDB | OR | ON  | 2008/06/19<br>15:28 |

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